ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International a	Composition Dec 2005. IPC, Bannockb and Pan-American co	c laration ourn, Illinois. A opyright conver	Il rights reserved u ntions.	nder both This docu level parts	ment is a dec , the declara	claration tion enc	n of the substances compasses all low	s within the manufactur er level materials for w	rer listed it hich the m	em. Note: if anufacturer	the item is an as the engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form T				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information			
upplier Information												
ompany name*	Company unique ID			Unique ID	Unique ID Authority				Response Date*			
nsemi									2024-04-25			
ontact Name	Title - Contact			Phone - C	Phone - Contact*				Email - Contact*			
Product-Env-Stewards	Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com			
uthorized Representative*	Title - Representative			Phone - R	Phone - Representative*			Email - Representative*				
roduct-Env-Stewards	Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number	Mfr Item Name		Effective	Date	Version	Manufacturing Site		Weight*	UOM	Unit Type
	NFAM30	NFAM3065L4BL SPM31, 650V/30		A Inverter IPM, Low noise	2024-04-25 VN5		VN5	8	3939.39	mg	Each	
Ianufacturing Proccess Info	ormation											
Terminal Plating / Grid Array Material Te		erminal Base Alloy J-STD-020 MSL Rat		-STD-020 MSL Rating	Peak Process Body Temperature		re Max Time at Peak	Temperat	ure Numb	er of Reflow Cyc	les	
Matte Tin (Sn) - annealed		CU Alloy NA		NA	0 C		30	secon	ds 3			
omments												
or more information regarding ma	terial composition	please refer to	page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge shall belief, is of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not ndependently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier rinto a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of hat agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides i										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight Unit of Measure		Level	Substance	CAS	Exempt	Weight	Unit of Measure
DBC	461.068	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		184.4272	mg
			Supplier	Copper (Cu)	7440-50-8		276.6408	mg
Die	51.5022	mg	Supplier	Silicon (Si)	7440-21-3		51.5022	mg
Die Attach	1.41124	mg		Epoxy resin	proprietary data		0.2173	mg
			Supplier	Imidazole Addition	68490-66-4		0.0226	mg
			Supplier	Silver (Ag)	7440-22-4		1.0867	mg
			В	Bismuth Trioxide (Bi2O3)	1304-76-3		0.0607	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.024	mg
Die Attach Solder	4.19991	mg	Supplier	Silver (Ag)	7440-22-4		0.105	mg
			Supplier	Tin (Sn)	7440-31-5		4.0739	mg
			Supplier	Copper (Cu)	7440-50-8		0.021	mg
Lead Frame	462.339	mg	Supplier	Silver (Ag)	7440-22-4		23.1169	mg
			Supplier	Zinc (Zn)	7440-66-6		0.5548	mg
			Supplier	Iron (Fe)	7439-89-6		11.0961	mg
			Supplier	Copper (Cu)	7440-50-8		427.2012	mg
			Supplier	Phosphorus (P)	7723-14-0		0.3699	mg
Mold Compound-Black	7922.92	mg	Supplier	Carbon Black (C)	1333-86-4		79.2292	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		6734.4819	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1109.2087	mg
Solder Wire	7.24278	mg	Α	Lead (Pb)	7439-92-1	7a	6.8806	mg
			Supplier	Tin (Sn)	7440-31-5		0.3621	mg
Wire Bond - Al	28.5763	mg	Supplier	Aluminum (Al)	7429-90-5		28.5763	mg
Wire Bond - Cu	0.1304	mg	Supplier	Copper (Cu)	7440-50-8		0.1304	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).